



The Future of Materials Engineering

Dramatic Innovation to the next 100 years

June 2019

International symposium (June 24, 2019 – June 25, 2019)

Invited talk: June 24 / Poster session: June 24 / Special lecture: June 25

Organizers

Daisuke Ando (Tohoku University) Chad Sinclair (University of British Columbia)
Mayu Muramatsu (Keio University) Yuta Saito (National Institute of Advanced Industrial Science and Technology)

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